

Taiko Workshop

3/27 (Sat) TBA

Spring 2010
Activity Registration Form

Payment: 2,000 yen
Registration Deadline: 3/17 (Wed)

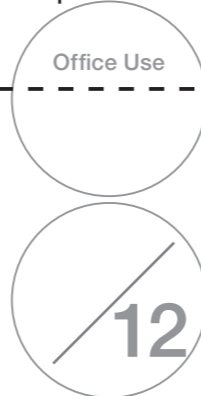
Student Name: _____

*This is your proof of registration. Please keep this copy until the day of the activity.
*Details of the activity and or any changes will be notified via e-mail to your temple e-mail account.
*All activity payments are non-refundable, unless the activity is canceled by OSS due to low participation or other unforeseen circumstances.

Taiko Workshop

3/27 (Sat) TBA

Payment: 2,000 yen
Registration Deadline: 3/17 (Wed)



Student Name: _____

Sex: Female Male

TUJ ID: _____ - _____

E-mail: _____@temple.edu

*All university related correspondences must go through official Temple University e-mail accounts.

Phone Number: _____ - _____

Program: Study Abroad Japan Admit (UG) Japan Admit (Bridge Program) AEP

Housing: Ontakesan Jiyugaoka Takadanobaba Akasaka Homestay Other

Please sign the Photo Release printed on back side. Thank you.

Photo Release Already Signed

I hereby consent and authorize Temple University, Japan Campus and Temple University (collectively "Temple") to take photographs or motion pictures of me; or to produce videotapes, audiotapes, closed-circuit television programs, web casts, or other types of media productions that capture my name, voice, likeness and/or image (collectively the "Materials"). I understand and agree that Temple shall have complete ownership of the Materials and specifically authorize Temple to copyright the Materials.

Without any notification, I understand and agree that Temple may use, reuse, copy, publish, display, exhibit, reproduce, license, or distribute the Materials in any educational or promotional materials or other forms of media including, without limitation, university publications, catalogs, articles, magazines, brochures, or websites. I further agree that I am executing this Release Form on a voluntary basis, and I will not receive any payment from Temple for signing this release or as a result of any publication of the Materials.

I have read and understand this Release.

Signature: _____ Date: _____ / _____ / 2010